



### GLASS PASSIVATED CHIP SINGLE-PHASE BRIDGE RECTIFIER

Reverse Voltage - 50 to 1000 Volts Forward Current 4.0 Amperes

#### Features

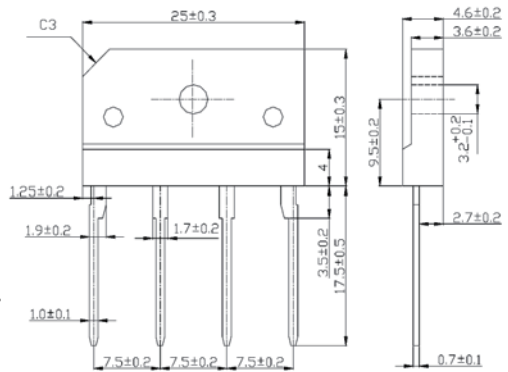
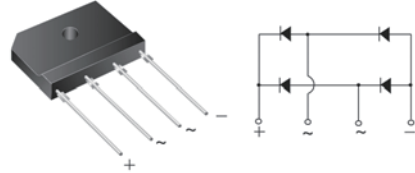
- ◆ Ideal for printed circuit boards
- ◆ High surge current capability
- ◆ High case dielectric strength of 2000 V<sub>RMS</sub>
- ◆ Glass passivated chip junction
- ◆ Plastic package has Underwriters Laboratory Flammability Classification 94V-0

#### Mechanical Data

- ◆ Case: KBJ(3S)  
Epoxy meets UL-94V-0 Flammability rating
- ◆ Terminals: Plated leads solderable per MIL-STD-750, Method 2026
- ◆ High temperature soldering guaranteed:  
260°C/10 seconds, 0.375 (9.5mm) lead length, 5 bs.(2.3kg) tension
- ◆ Polarity: As marked on body
- ◆ Mounting Torque: 10 cm-kg (8.8 inches-lbs) max.
- ◆ Recommended Torque: 5.7 cm-kg (5 inches-lbs)

#### Typical Applications

General purpose use in ac-to-dc bridge full wave rectification for Monitor, TV, Printer, Switching Mode Power Supply, Adapter, Audio equipment, and Home Appliances applications



Package outline dimensions in millimeters

#### Maximum Ratings and Electrical Characteristics

Rating at 25°C ambient temperature unless otherwise specified.

Parameter	Symbols	KBJ4A	KBJ4B	KBJ4D	KBJ4G	KBJ4J	KBJ4K	KBJ4M	Units
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	50	100	200	400	600	800	1000	Volts
Maximum RMS voltage	V <sub>RMS</sub>	35	70	140	280	420	560	700	Volts
Maximum DC blocking voltage	V <sub>DC</sub>	50	100	200	400	600	800	1000	Volts
Maximum average forward rectified output current at T <sub>C</sub> =100°C T <sub>A</sub> =25°C	I <sub>F(AV)</sub>				4.0 <sup>(1)</sup> 2.3 <sup>(2)</sup>				Amps
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I <sub>FSM</sub>				80.0				Amps
Rating for fusing (t<8.3ms)	Pt				26				A <sup>2</sup> sec
Maximum instantaneous forward voltage drop per leg at 2.0A	V <sub>F</sub>				1.0				Volt
Maximum DC reverse current at rated DC blocking voltage per leg T <sub>A</sub> =25°C T <sub>A</sub> =125°C	I <sub>R</sub>				5.0 250.0				µA
Typical thermal resistance per leg	R <sub>θJA</sub> R <sub>θJC</sub>				26 <sup>(2)</sup> 5 <sup>(1)</sup>				°C/W
Dielectric strength (Terminals to case, AC 1 minute)	V <sub>ISO</sub>				2000				Volts
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>STG</sub>				-55 to +150				°C

- Notes**
1. Unit case mounted on 6.3x6.3x0.15cm thick Al plate heatsink.
  2. Units mounted on P.C.B. with 0.5 x 0.5" (13 x 13 mm) copper pads and 0.375" (9.5 mm) lead length
  3. Recommended mounting position is to bolt down on heatsink with silicone thermal compound for maximum heat transfer with #6 screw



## RATINGS AND CHARACTERISTIC CURVES

( $T_A = 25^\circ\text{C}$  unless otherwise noted)

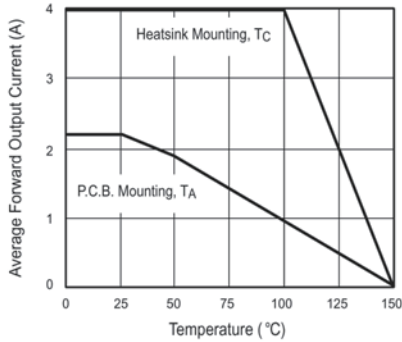


Figure 1. Derating Curve Output Rectified Current

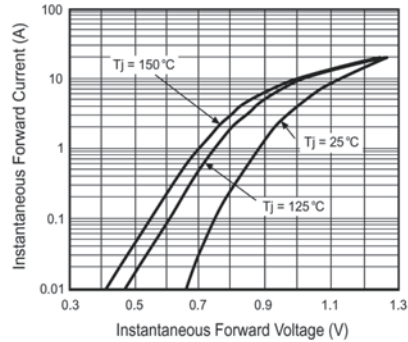


Figure 3. Typical Forward Characteristics Per Leg

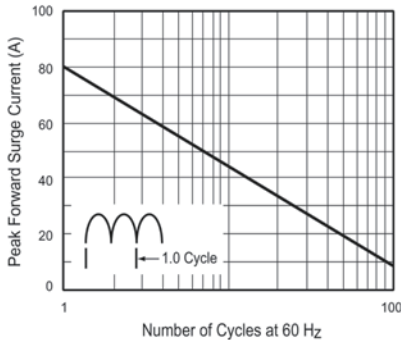


Figure 2. Maximum Non-Repetitive Peak Forward Surge Current Per Leg

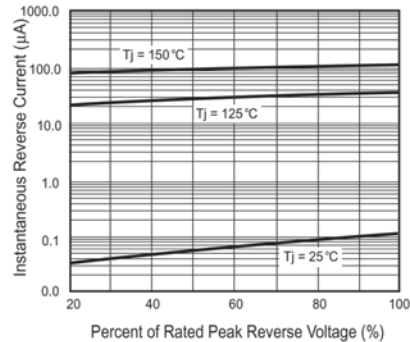


Figure 4. Typical Reverse Characteristics Per Leg

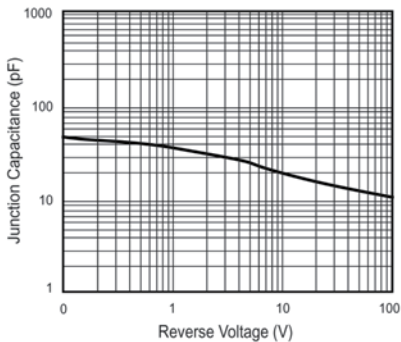


Figure 5. Typical Junction Capacitance Per Leg

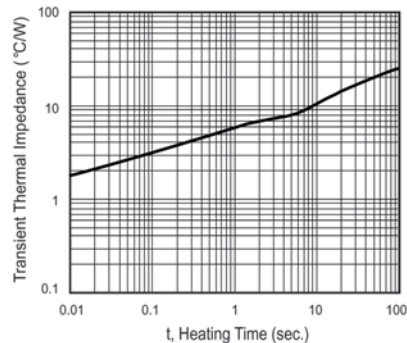


Figure 6. Typical Transient Thermal Impedance Per Leg